

Overview

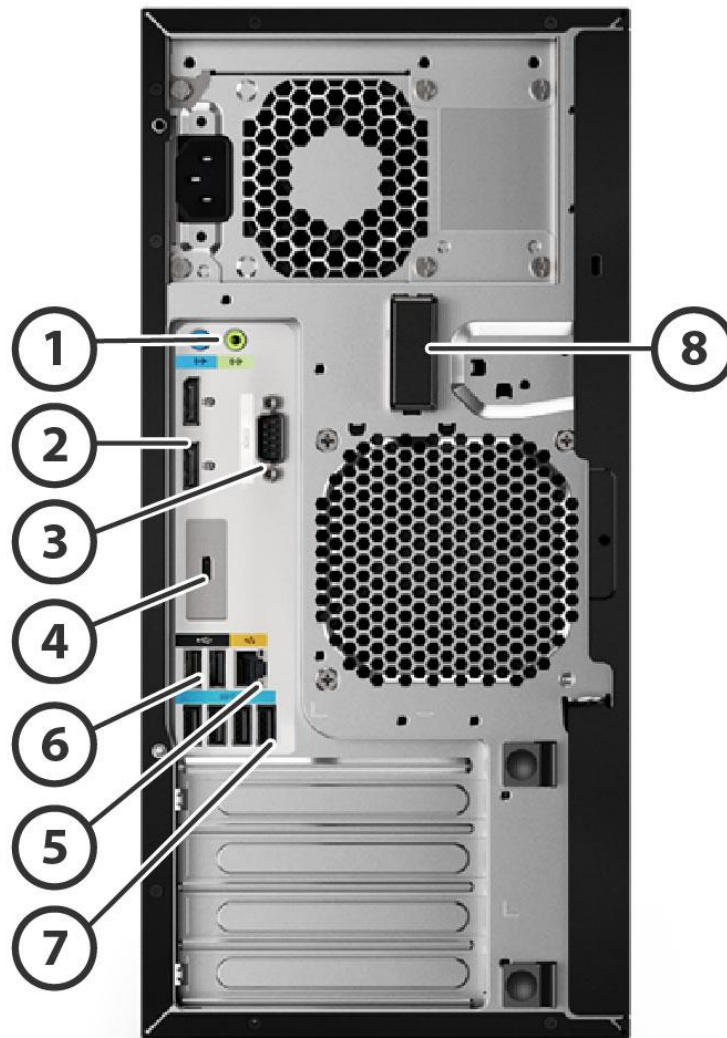
HP Z2 Tower G4 Workstation



1. Power Button
2. Headphone/Microphone
3. 1 USB 3.0 port
4. 1 USB 3.0 Battery Charging Port
5. (Optional) 1 USB 3.1 Gen2 Type-C™ Battery Charging Port

6. Optional SD Card Reader
7. External 5.25" bay

Overview



1. 1 Audio Line In, 1 Audio Line Out,
2. 2 DisplayPort™ (DP 1.2) output from Intel® UHD graphics (available on selected processors only)
3. Optional Serial Port
4. 1 flex I/O module for 2nd LAN/VGA/HDMI/DP/ USB-C 3.1 Gen2 Charging Port with Alt mode /Thunderbolt™ 3.0 (Thunderbolt™ requires x4 PCIe Add in card)
5. RJ-45 to integrated GBe
6. 2 USB 2.0
7. 4 USB 3.0
8. Optional WLAN/BT Antenna

Overview

Form Factor

Minitower

Operating Systems

Preinstalled:

- Windows 10 Home 64*
- Windows 10 Pro 64*
- Windows 10 Pro (National Academic License)*
- Windows 10 Pro for Workstations – HP recommends Windows 10 Pro *
- HP Linux®-ready

Supported:

- Red Hat® Enterprise Linux® Workstation (1 year paper license available; Preinstall not available)

* Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.microsoft.com>.

NOTE: For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

Processors

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology ³	Cache (MB)	Memory Speed (MT/s)	Hyper-Threading	Integrated Graphics	Featuring Intel® vPro™ Technology ⁴	16GB Intel® Optane™ memory ^{2,*}	TDP (W)
Intel® Xeon® processor E-2176G ¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics	Y	N	80W
Intel® Xeon® processor E-2174G ¹	4	3.8	4.7	8	2666	Y	Intel® UHD Graphics	Y	N	71W
Intel® Xeon® processor E-2144G ¹	4	3.6	4.5	8	2666	Y	Intel® UHD Graphics	Y	N	71W
Intel® Xeon® processor E-2136 ¹	6	3.3	4.5	12	2666	Y	N/A	Y	N	80W
Intel® Xeon® processor E-2126G ¹	6	3.3	4.5	12	2666	N	Intel® UHD Graphics	Y	N	80W
Intel® Xeon® processor E-2124G ¹	4	3.4	4.3	8	2666	N	Intel® UHD Graphics	Y	N	71W
Intel® Xeon® processor E-2104G ¹	4	3.2	N/A	8	2666	N	Intel® UHD Graphics	Y	N	65W
Intel® Core™ i7-8700K processor ¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics	Y	N	95W
Intel® Core™ i7+8700K processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2,*}	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics 630	Y	Y	95W
Intel® Core™ i7-8700 processor ¹	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics	Y	N	65W

Overview

Intel® Core™ i7+8700 processor (Core i7 and 16GB Intel® Optane™ memory) ^{1,2,*}	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5-8600 processor ¹	6	3.1	4.2	9	2666	N	Intel® UHD Graphics	Y	N	65W
Intel® Core™ i5+8600 processor (Core i5 and 16GB Intel® Optane™ memory) ^{1,2,*}	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i5-8500 processor ¹	6	3.0	4.0	9	2666	N	Intel® UHD Graphics	Y	N	65W
Intel® Core™ i5+8500 processor (Core i5 and 16GB Intel® Optane™ memory) ^{1,2,*}	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Y	Y	65W
Intel® Core™ i3-8100 processor ¹	4	3.6	N/A	6	2400	N	Intel® UHD Graphics	N	N	65W
Intel® Pentium™ G5400 processor ¹	2	3.7	N/A	4	2400	Y	Intel® UHD Graphics	N	N	54W

¹Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

²Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

*16GB Intel® Optane™ memory Available Fall 2018

³The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See <http://www.intel.com/technology/turboboost> for more information.

⁴vPro. Some functionality of this technology, such as Intel® Active management technology and Intel® Virtualization technology, requires additional 3rd party software in order to run. Availability of future “virtual appliances” applications for Intel vPro technology is dependent on third-party software providers. Compatibility of this generation of Intel vPro technology-based hardware with future “virtual appliances” is yet to be determined.

NOTES

Integrated Intel® UHD graphics P630 is supported on the select Intel® Xeon E processors.

Intel® Xeon® E, Intel® Core™ i3 and Intel® Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

Overview

Color	Black
Expansion Slots (see system board section for more details)	1 PCIe Gen3 x16 slot 1 PCIe Gen3 x4 slot /x16 connector 1 PCIe Gen3 x1 slot/x4 connector 1 PCIe Gen3 x1 slot/x4 connector 2 M.2 storage (PCIe Gen3 x4)* 1 M.2 Wlan (PCIe Gen3 x1+ intel CNVI)*
	NOTE: The PCIe Gen 3 x16 slot is meant for HP qualified cards, configured or after market. HP does not provide warranty support for 3rd party cards.
	* M.2 storage supports compatible devices up to 110mm
Expansion Bays (see storage section for more details)	2 external Half Height 5.25" Bays 2 internal 3.5" Drive Bays
Front I/O	1 USB 3.0, 1 USB 3.0 Charging Data Port, 1 Headphone/Microphone. 1 USB3.1 Gen2 Type-C Charging Data Port (Optional), 1 SD Card Reader (Optional).
Internal I/O	1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x6 (3.0 x1, 2.0 x1) and 2x5 (2.0 x2) header: supports one USB 3.0 Media Card Reader.
Rear I/O	2 DisplayPort™ (DP 1.2) outputs from Intel® UHD Graphics (available on specific processors only); 4 USB 3.0 ports, 2 USB 2.0 ports, 1 serial port (optional), 1 parallel port (optional), 2 PS/2 (optional), RJ-45 (LOM), 1 Flex IO port (3 rd DisplayPort™/HDMI/VGA/2 nd 1GbE LAN/ USB-C 3.1 Gen2 Charging Port with Alt mode/Thunderbolt™ 3.0-Thunderbolt™ 3.0 PCIe card utilizes Flex IO option) , (1 Audio Line-in, and 1 Audio Line-out.
Interfaces Supported	SD Media Card Reader (optional) USB-C 3.1 Gen2 Charging Port (optional)
Chassis Dimensions (H x W x D)	Standard minitower orientation: 356 mm x 169 mm x 435 mm (14.0 x 6.7 x 17.1 in)
Weight	Exact weights depend upon configuration: Minimum: 7.0 kg (15.43 lb) Typical*: 8.2 kg (18.03 lb) Maximum: 11.4 kg (25.18 lb) Supported Weight (desktop orientation): 35 kg (77 lb) Packaging (H x W x D): 599 x499 x 295 mm(23.58 x 19.65 x 11.6 in) Shipping Weight: 11.47 kg(25.26 lb) * Typical weight when configured with 1 3.5" hard drives, 1 optical drive, 2 DIMMs and 1 NVIDIA® Quadro® P1000 graphics card
Power Supply	500W wide-ranging, active Power Factor Correction, 90 Efficient 250W 92% Efficiency wide-ranging, active PFC Power Supply option. NOTE: The Power Supply Efficiency Report for the 500W 90% Efficiency and 250W 92% Efficiency Power Supply may be found at the following link:

Overview

https://plugloadsolutions.com/psu_reports/HP%20INC_PA-4501-1_500W_SOCE%205175_Report.pdf
https://plugloadsolutions.com/psu_reports/ACBEL%20POLYTECH%20INC._PCH022_250W_SOCE%205174_Report.pdf

Backup Devices

For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup System offerings, please visit <http://www.hp.com/go/connect>

Chipset

Intel® C246 chipset

Memory

4 DIMM slots, supporting up to 64GB ECC/non-ECC, DDR4 2666 MT/s speed depending on the CPU selection.

Supported Components

Processors

	Factory Configured	Option Kit
Intel® Xeon® processor E-2100 family²		
Intel® Xeon® processor E-2176G	Y	N
Intel® Xeon® processor E-2174G	Y	N
Intel® Xeon® processor E-2144G	Y	N
Intel® Xeon® processor E-2136	Y	N
Intel® Xeon® processor E-2126G	Y	N
Intel® Xeon® processor E-2124G	Y	N
Intel® Xeon® processor E-2104G	Y	N
8th generation Intel® Core™ processor family³		
Intel® Core™ i7-8700K 3.7 2666 6C CPU	Y	N
Intel® Core™ i7+8700K (Core i7 and 16GB Intel® Optane™ memory*) 3.7 2666 6C CPU	Y	N
Intel® Core™ i7-8700 3.2 2666 6C CPU	Y	N
Intel® Core™ i7+8700 (Core i7 and 16GB Intel® Optane™ memory*) 3.2 2666 6C CPU	Y	N
Intel® Core™ i5-8600 3.1 2666 6C CPU	Y	N
Intel® Core™ i5+8600 (Core i5 and 16GB Intel® Optane™ memory*) 3.1 2666 6C CPU	Y	N
Intel® Core™ i5-8500 3.0 2666 6C CPU	Y	N
Intel® Core™ i5+8500 (Core i5 and 16GB Intel® Optane™ memory*) 3.0 2666 6C CPU	Y	N
8th generation Intel® Core™ i3/Pentium processor family²		
Intel® Core™ i3-8100 3.6 2400 4C CPU	Y	N
Intel® Pentium® G5400 3.7 2400 2C CPU	Y	N

NOTE 1: Intel® Integrated P630 Graphics for select Xeon E processors supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications, compared to Intel® UHD Graphics 630.

NOTE 2: These processors support either ECC or non-ECC memory

NOTE 3: These processors support only non-ECC memory

NOTE 4: Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

*16GB Intel® Optane™ memory Available Fall 2018

Monitors / Displays

	Factory Configured	Option Kit	Option Kit Part Number
HP Z Display Z27n G2 27-inch IPS LED Backlit Monitor		Y	1JS10AA
HP Z Display Z24n G2 24-inch IPS LED Backlit Monitor		Y	1JS09AA
HP Z Display Z24nf G2 23.8-inch IPS Backlit Monitor		Y	1JS07AA
HP Z Display Z23n G2 23-inch IPS LED Backlit Monitor		Y	1JS06AA
HP Z Display Z22n G2 21.5-inch IPS LED Backlit Monitor		Y	1JS05AA

Supported by all Operating Systems available from HP
Screen Size Diagonally Measured

Supported Components

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ036AA
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	LQ037AA
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	QB576AA
	4TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	K4T76AA
	6TB SATA 7200 rpm 6Gb/s 3.5" HDD	Y	Y	3DH90AA
	500GB SATA 7.2K SED SFF HDD	Y	N	(N/A as AMO)
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Y	Y	W0R10AA
SATA Solid State Drives				
	HP 256GB SATA 6Gb/s SSD	Y	Y	A3D26AA
	HP 512GB SATA 6Gb/s SSD	Y	Y	D8F30AA
	HP 1TB SATA 6Gb/s SSD	Y	Y	F3C96AA
	HP 2TB SATA 6Gb/s SSD	Y	Y	Y6P08AA
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	Y	Y	G7U67AA
	HP Enterprise Class 240GB SATA SSD	Y	Y	T3U07AA
	HP Enterprise Class 480GB SATA SSD	Y	Y	T3U08AA
	16GB Intel® Optane™ memory*,**	Y	Y	2EB68AA

*Intel® Optane™ memory (cache) is sold separately. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z2 Tower/SFF/Mini G4, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core™ processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® Optane™ supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe™ Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 16.5 driver.

**16GB Intel® Optane™ memory Available Fall 2018

PCIe SSDs

PCIe SSDs for HP Workstations

HP Z Turbo Drv G2 1TB TLC PCIe SSD **	Y	Y	Y1T53AA
HP Z Turbo Drv G2 256GB TLC PCIe SSD **	Y	Y	Note 1
HP Z Turbo Drv G2 512GB TLC PCIe SSD **	Y	Y	Note 1
Intel® 905p Series SSD (Optane SSD)			
Intel® Optane SSD 905p 280GB AiC*,***	Y	Y	2SC47AA
Intel® Optane SSD 905p 480GB AiC*,***	Y	Y	2SC48AA

* PCIe card installed in standard PCIe x4 slot

** Installed in native M.2 storage slot Z2 G4

*** Intel® Optane SSD Available Fall 2018

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for system recovery software.

Supported Components

NOTE: The HP Z2 Tower G4 Workstation is capable of configuring up to 2 Z Turbo Drives. By default, the Z Turbo Drive configured will be installed in the M.2 storage slot on the system's motherboard.

Hard Drive Controllers

	Factory Configured	Option Kit
Integrated SATA Controller (Z2 G4)		
Integrated SATA Controller, RAID 0,1 supported: 4x 6 Gb/s ports	Y	N
Factory integrated RAID on motherboard for SATA drives		
RAID 0 Data Configuration	Y	N
RAID 1 Data Configuration	Y	N
Factory integrated RAID on motherboard for Z Turbo Drive		
RAID 0 Boot or Data Configuration	Y	N
RAID 1 Boot or Data Configuration	Y	N

NOTE: SATA hardware RAID is not supported on Linux® systems. The Linux® kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. All drives must be identical in type and capacity. Boot volume/RAID array must be less than 2 TB

NOTE 1: Requires identical drives (speeds, capacity, and interface).

Graphics

	Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
Integrated Intel® UHD Graphics Media Accelerators (Z2 G4)				
Intel® UHD Graphics P630	Y	N		1
Intel® UHD Graphics 630	Y	N		1
Intel® UHD Graphics 610	Y	N		1
Graphics Cable Adapters				
HP DisplayPort™ to Dual Link DVI Adapter	N	Y	NR078AA	1
HP DisplayPort™ To DVI-D Adapter (4-Pack)	N	N		1
HP DisplayPort™ To DVI-D Adapter (2-Pack)	Y	N		1
HP DisplayPort™ To DVI-D Adapter	Y	Y	FH973AA	1
HP DisplayPort™ To VGA Adapter	N	Y	AS615AA	1
HP Display to HDMI Adapter	N	Y		
HP miniDP to DP Adapter	N	Y		
HP USB-C to VGA Adapter	N	Y		
HP USB-C to HDMI Adapter	N	Y		
HP USB-C to DP Adapter	N	Y		

Entry 3D

Supported Components

AMD Radeon™ Pro WX 3100 4GB Graphics	Y	Y	2TF08AA	2
NVIDIA® Quadro® P400 2GB Graphics	Y	Y	1ME43AA	2
NVIDIA® Quadro® P620 2GB Graphics	Y	Y	3ME25AA	1
Mid-range 3D				
AMD Radeon™ Pro WX 4100 4GB Graphics	N	Y	Z0B15AA	1
NVIDIA® Quadro® P1000 4GB Graphics	Y	Y	1ME01AA	2
NVIDIA® Quadro® P2000 5GB Graphics	Y	Y	1ME41AA	1
High End 3D				
AMD Radeon™ Pro WX 7100 8GB Graphics*	Y	Y	Z0B14AA	1
NVIDIA® Quadro® P4000 8GB Graphics	Y	Y	1ME40AA	1
NVIDIA® Quadro® P5000 16GB Graphics	Y	Y	1ME40AA	1

* Requires 500W PSU. Not supported with 250W PSU.

NOTE 1: Intermixing integrated Intel® UHD graphics and discrete graphics cards in order to drive more than three displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics when four or more displays are required to be supported.

Memory

DDR4-2666 ECC Unbuffered DIMMs - CTO

8GB DDR4-2666 ECC (1x8GB) RAM
 16GB DDR4-2666 ECC (2x8GB) RAM
 32GB DDR4-2666 ECC (4x8GB) RAM
 32GB DDR4-2666 ECC (2x16GB) RAM
 64GB DDR4-2666 ECC (4x16GB) RAM

DDR4-2666 non-ECC Unbuffered DIMMs – CTO

4GB DDR4-2666 nECC (1x4GB) RAM
 8GB DDR4-2666 nECC (2x4GB) RAM
 8GB DDR4-2666 nECC (1x8GB) RAM
 16GB DDR4-2666 nECC (2x8GB) RAM
 32GB DDR4-2666 nECC (2x16GB) RAM
 32GB DDR4-2666 nECC (4x8GB) RAM
 64GB DDR4-2666 nECC (4x16GB) RAM

NOTES:

Supported Components

Intel® Xeon E, Intel® Core™ i3 and Intel® Pentium processors can support either ECC or non-ECC memory; Intel® Core™ i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

Max transfer rates up to 2666 MT/s

AM0

Option Kit Part Number

DDR4-2666 ECC Unbuffered DIMMs – AM0

HP 8GB (1x8GB) DDR4-2666 ECC Unbuffered RAM	3TQ39AA
HP 16GB (1x16GB) DDR4-2666 ECC Unbuffered RAM	3TQ40AA

DDR4-2666 non-ECC Unbuffered DIMMs – AM0

HP 4GB (1x4GB) DDR4-2666 nECC Unbuffered RAM	3TQ31AA
HP 8GB (1x8GB) DDR4-2666 nECC Unbuffered RAM	3PL81AA
16GB (1x16GB) DDR4-2666 nECC Unbuffered RAM	3PL82AA

NOTE: Only unbuffered DDR4 DIMMs are supported.

The CPUs determine the speed at which the memory is clocked. If a 2400 MHz capable CPU is used in the system, the maximum speed the memory will run at is 2400 MHz regardless of the specified speed of the memory.

Multimedia and Audio Devices

Integrated Conexant CX20632 5.1 HDA codec

Factory Configured

Y

Option Kit

N

Option Kit Part Number

Optical and Removable Storage

HP 9.5mm Slim DVD Writer
HP 9.5mm Slim DVD-ROM Drive
HP 9.5mm Slim BDXL Blu-Ray Writer
HP SD Media Card Reader

Factory Configured

Y

Y

Y

Y

Option Kit

Y

Y

Y

Y

Option Kit Part Number

K3R64AA

K3R63AA

K3R65AA

HDD Frame/Carriers

HP DX175 Removable HDD Carrier
HP DX175 Removable HDD Frame/Carrier

N

N

Y

Y

1ZX72AA

1ZX71AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Supported Components

Controller Cards

	Factory Configured	Option Kit	Option Kit Part Number
HP Thunderbolt™ 3 PCIe 3-port I/O Card	Y	Y	4CX35AA

NOTE 1: Utilizes Flex IO port connection for flex port

NOTE: HP Thunderbolt™ 3 PCIe I/O Card is not available until September 2018

Networking and Communications

	Factory Configured	Option Kit	Option Kit Part Number
Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel® AMT 12.0)	Y	N	
Intel® X710-DA2 2-Port 10GbE SFP+ NIC	Y	Y	1QL47AA
HP 10GbE SFP+ SR Transceiver	Y	Y	C3N53AA
Intel® X550-T2 2-Port 10GbE NIC	Y	Y	1QL46AA
Intel® 9560 802.11 a/b/g/n/ac with Bluetooth® 5 M.2	Y	N	
Intel® I350-T2 2-Port 1GbE ⁽³⁾ NIC	Y	Y	V4A91AA
Intel® I350-T4 4-Port 1GbE ⁽³⁾ NIC	N	Y	W8X25AA
Aquantia AQN-108 1-Port 5GbE NIC	Y	Y	1PM63AA

NOTE 1: The integrated network connection is required to support Intel® vPro™ Technology.

NOTE 2: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

NOTE 3: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security

	Factory Configured	Option Kit	Option Kit Part Number
Kensington Lock	N	Y	
HP Z4/6 Depth Adjustable Fixed Rail Rack Kit	N	Y	2HW42AA
HP Solenoid Lock and Hood (TWR) Sensor	Y	Y	E0X96AA
HP Business PC Security Lock Kit	N	Y	PV606AA
HP UltraSlim Cable Lock Kit	N	Y	T1A62AA

Supported Components

Input Devices

	Factory Configured	Option Kit	Option Kit Part Number
HP USB Optical Mouse	Y	Y	QY777AA
HP PS/2 Mouse	N	Y	QY775AA
HP USB Hardened Mouse	Y	Y	P1N77AA
HP USB Premium Mouse	Y	Y	
HP Premium Wireless Mouse	Y	Y	
SpaceMouse Pro USB 3D Input Device	N	Y	
3Dconnexion CADMouse	N	Y	M5C35AA
HP USB Business Slim CCID SmartCard Keyboard	Y	Y	
HP USB Business Slim Keyboard	Y	Y	N3R87AA
HP PS/2 Business Slim Keyboard	N	Y	
HP USB Premium Keyboard	Y	Y	N3R86AA
HP Premium Wireless Keyboard	Y	Y	
HP Wireless Business Slim Keyboard & Mouse	Y	Y	

Other Hardware

	Factory Configured	Option Kit	Option Kit Part Number
HP Power Cord Kit	N	Y	DM293A
HP Workstation Mouse Pad (Japan only)	Y	N	
HP Serial Port Adapter	Y	Y	3TK82AA
HP Serial + PS/2 Adapter	Y	Y	1VD82AA
HP ENERGY STAR® Certified Configuration	Y	N	
HP eSATA PCI Cable Kit	Y	Y	FH966AA
HP Z2 Tower G4 Bezel w/ Dust Filter option	N	Y	4KY89AA
HP PCIe x1 Parallel Port Card	N	Y	N1M40AA
Z2 Tower G4 Dust Filter (filter only)	N	Y	3TQ24AA
HP Z2 G4 TWR Front Card Guide Kit	Y	Y	4KY82AA

Flex Module (Rear IO)

	Factory Configured	Option Kit	
HP Flex IO module (VGA)	Y	Y	3TK80AA
HP Flex IO module (HDMI)	Y	Y	3TK74AA
HP Flex IO module (DP)	Y	Y	3TK72AA
HP Flex IO module (USB-C)*	Y	Y	4KY84AA
HP Flex IO module (1 Gbe LAN)	Y	Y	3TQ26AA

*The DP alt mode will not function if the CPU does not support integrated graphics or if integrated graphics is disabled.

Software

	Factory Configured	Option Kit	Support Notes
HP Performance Advisor	Y	N	Note 1
HP Velocity	Y	N	
HP Remote Graphics Software (RGS) 7.x	Y	N	
HP PC Hardware Diagnostics UEFI	Y	N	Note 2

Supported Components

HP Client Security Software

Y

N

NOTE 1: Supports, and preinstalled with Windows 10 only. Also available as a free download from <http://www.hp.com/go/performanceadvisor>

NOTE 2: Windows OS only

Operating Systems

Windows 10 Home 64

Windows 10 Pro 64

Windows 10 Pro (National Academic License)

Windows 10 Pro for Workstations – HP recommends Windows 10 Pro

Red Hat® Enterprise Linux® (RHEL) Workstation – Paper License (1yr)

NOTE: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux_hardware_matrix

<http://www.microsoft.com/windows/windows-7/>

Supported Components

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability – HP BIOS provides several technologies that help integrate the HP Z2 G4 Workstation into the enterprise, such as PXE, remote recovery, remote configuration, remote control, and BIOS (F10) Setup support for 14 languages.
- Network firmware updates – Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability – HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification version 2.6
- Absolute Persistence agent – For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management – The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance – Industry leading acoustic emissions across the range of operating conditions.
- Serviceability – HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery – HP BIOS provides numerous ways to upgrade HP Workstation computers, including BIOS updates from within Windows (HP Firmware Update and Recovery), HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

- Power-On password – Helps prevent an unauthorized user from powering on the system.
- Administrator password – Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
 - Power to expansion connectors / slots
 - Wake events other than power buttons (such as wake on LAN)
 - USB charging ports

HP Sure Start Gen4 Start

- BIOS Integrity checking – Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS – Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.

Supported Components

- Audit enabled – System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS

HP BIOSphere Gen4¹⁷
HP DriveLock & Automatic DriveLock
BIOS Update via Network
Master Boot Record Security
Power On Authentication Authentication
Secure Erase¹⁸
Absolute Persistence Module¹⁹
Pre-boot Authentication
HP Wireless Wakeup

Software

HP Hotkey Support
HP Performance Advisor
HP Velocity
HP Remote Graphics Software (RGS) 7.x

Manageability Features

HP Driver Packs²²
HP System Software Manager (SSM)
HP BIOS Config Utility (BCU)
HP Client Catalog
HP Manageability Integration Kit Gen2²³

Client Security Software

HP Client Security Suite Gen4²⁵ including:
HP Security Manager²⁶ (including Credential Manager, HP Password Manager, HP Spare Key)
HP Device Access Manager
HP Power On Authentication Authentication
Microsoft Defender²⁷

Security Management

Secure Erase¹⁸
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)³²
SATA port disablement (viaBIOS)
RAID configurations³³
Serial, USB enable/disable (viaBIOS)
Power-on password (viaBIOS)
Setup password (viaBIOS)
Support for chassis padlocks and cable lock devices
Integrated hood sensor
HP Sure Click³⁷
HP Sure Start Gen4³⁰
HP Sure Run³⁵

Supported Components

HP Sure Recover³⁶

17. HP BIOSphere Gen4 features may vary depending on the Workstation platform and configurations requires 8th Gen Intel® processors.

18. Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88. Supported on Workstation platforms with BIOS version F.03 or higher.

19. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: <http://www.absolute.com/company/legal/agreements/computrace-agreement>. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software. Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

22. HP Driver Packs not preinstalled, however available for download at <http://www.hp.com/go/clientmanagement>.

23. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>

25. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.

26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.

27. Microsoft Defender Opt in and internet connection required for updates.

30. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors

32. Firmware TPM is version 7.6. Hardware TPM is v2.0.

33. RAID configuration is optional and does require a second hard drive.

35. HP Sure Run is available on HP Workstation products equipped with 8th generation Intel® or AMD® processors.

36. HP Sure Recover is available on HP Workstations with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data.

38. HP Sure Click is available on select HP Workstation platforms and supports Microsoft® Internet Explorer and Chromium™. Check <http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW> for all compatible platforms as they become available

System Technical Specifications

System Board

System Board Form Factor	ATX 24.89 x 24.38 mm (9.8 x 9.6 inches)
Processor Socket	Single LGA-1151
CPU Bus Speed	DMI
Chipset	Intel® PCH C246
Memory Expansion Slots	4 DDR4 memory slots
Memory Type Supported	DDR4, UDIMM (Unbuffered), ECC& non-ECC
Memory Modes	Non-Interleaved for single channel. Interleaved when both channels are populated.
Memory Speed Supported	2666MT/s DDR4
Memory Protection	ECC available on data
Maximum Memory	64GB
Memory Configuration (Supported)	4GB, 8GB and 16GB non-ECC/8GB and 16GB ECC unbuffered DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed on the same system. NOTE: * Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 10 Professional 64 bit, Red Hat Linux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.
PCI Express Connectors	• 1 PCI Express Gen3 slot x16 mechanical/ x16 electrical (full height, full length) • 1 PCI Express Gen3 slot x4 mechanical/ x1 electrical (full height, full length) • 1 PCI Express Gen3 slot x4 mechanical/ x1 electrical (full height, full length) • 1 PCI Express Gen3 slot x16 mechanical/ x4 electrical (full height, full length) • 2 M.2 Storage (PCIe Gen3 x4)¹ • 1 M.2 WLAN (PCIe Gen3 x1+ Intel CNVi) In the PCIe Gen3 (x16 electrical/x16 mechanical) slot, it intent to supported HP certified added in card. Note1: M.2 storage supports compatible devices up to 110mm
Supported Drive Interfaces	SATA Integrated (4) Serial ATA interfaces (6Gb/s SATA). One port can optionally be used for eSATA. RAID 0 and 1 supported. Factory integrated RAID is Microsoft Windows only. RAID 5 is supported by Software XOR. Serial Attached SCSI None Integrated RAID NOTE: Requires identical hard drives (speeds, capacity, interface) Integrated Graphics Intel® UHD Graphics 630 (on Core i3/i5/i7-8xxx processors); Intel® Integrated Graphics P630 for Xeon processors Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics display. Support for Microsoft DirectX 12, OpenGL 4.4 and OpenCL 2.0 on Intel® UHD Graphics P630; 3 DP 1.2 graphics ports integrated in motherboard; Supports up to three simultaneous displays across DP & DVI-D outputs. Max. resolution supported on DP 1.2 ports: 3840x2160 @60Hz

System Technical Specifications

	Network Controller	Integrated Ethernet PHY Connection I219LM. Management capabilities: WOL, PXE 2.1 and AMT 12
	External SATA (eSATA)	1 port eSATA capable (SATA 3)
	IDE connector	No
	Floppy connector	No
	Serial	1 internal header (requires optional Serial Port Adapter Kit)
	2nd Serial	requires optional Serial Port Adapter Kit
	HD Integrated Audio	Yes
USB Connector(s)	Front	1 USB-A 3.0, 1 USB-A 3.0 Charging Data Port and 1 USB-C 3.1 Gen2 Charging Data Port (Optional).
	Rear	4 USB-A 3.0, 2 USB-A 2.0, and 1 USB-C 3.1 Gen2 Charging Port with Alt mode (Optional via Flex module).
	Internal	1 USB 3.0 and 2 USB 2.0 ports available as 2 separate 2x6(3.0 x1, 2.0 x1) and 1x6(2.0 x1) headers: one USB 3.0 SD Card Reader.
	HD Integrated Audio	Yes
	Flash ROM	Yes
	CPU Fan Header	Yes
	Chassis Fan Header	1 Rear System Chassis Fan Header
	Front Control Panel/Speaker Header	Yes
	CMOS Battery Holder - Lithium	Yes
	Integrated Trusted Platform Module	Integrated TPM 2.0 Convertible to FIPS 140-2 Certified mode through firmware v7.80 The TPM module disabled where restricted by law, i.e. Russia.
	Power Supply Headers	Yes
	Power Switch, Power LED & Hard Drive LED Header	Yes
	Clear Password Jumper	Yes
	Keyboard/Mouse	USB or PS/2 (option)
	Power Supply	

System Technical Specifications

System Configurations							
Z2 G4 TWR Configuration #1 (TBD)	Processor Info	1x Intel® Core™ i3-8100 3.6 6MB 65W CPU					
	Memory Info	8GB (1x 8GB) 2666 MHz DDR4 non-ECC					
	Graphics Info	Intel® UHD Integrated Graphics 630					
	Disks/Optical/Floppy	1x SATA 1 TB 7.2k rpm/ 1x 9.5mm Slim ODD					
	PSU	250W 92%					
	Other						
Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	12.587		12.670		12.739	
	Windows short Idle (S0)	12.896		13.661		13.364	
	Windows Busy Typ (S0)	69.975		69.728		71.296	
	Windows Busy Max (S0)	80.448		90.18		91.721	
	Sleep (S3)	1.100	1.031	1.192	1.099	1.213	1.117
	Off (S5)	0.605	0.568	0.594	0.567	0.602	0.583
	Zero Power Mode (EuP)	0.273		0.277		0.276	
Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	42.946		43.230		43.465	
	Windows short Idle (S0)	44.001		46.611		45.598	
	Windows Busy Typ (S0)	238.755		237.912		243.262	
	Windows Busy Max (S0)	274.489		307.694		312.952	
	Sleep (S3)	3.753	3.518	4.067	3.750	4.139	3.811
	Off (S5)	2.064	1.938	1.873	1.965	2.054	1.989
	Zero Power Mode (EuP)	0.931		0.954		0.942	
Z2 G4 TWR Configuration #2 (TBD) typical® CERTIFIED	Processor Info	1x Intel® Core™ i7-8700 3.212MB 65W CPU					
	Memory Info	16GB (2x 8GB) 2666 MHz DDR4 non-ECC					
	Graphics Info	1x NVIDIA® Quadro® P1000 4GB Graphics					
	Disks/Optical/Floppy	1x SATA 1 TB 7.2k rpm/ 1x9.5mm Slim ODD					
	PSU	500W 90%					
	Other						
Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	20.826		19.160		21.173	
	Windows short Idle (S0)	23.431		20.143		22.574	
	Windows Busy Typ (S0)	163.787		159.623		162.867	
	Windows Busy Max (S0)	177.41		173.52		180.23	
	Sleep (S3)	1.435	1.321	1.424	1.301	1.360	1.273
	Off (S5)	0.658	0.642	0.664	0.627	0.641	0.620
	Zero Power Mode (EuP)	0.303		0.325		0.303	
Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	71.058		65.374		72.242	

System Technical Specifications

	Windows short Idle (S0)	79.947		68.728		77.022	
	Windows Busy Typ (S0)	558.841		544.634		555.702	
	Windows Busy Max (S0)	605.323		592.050		614.945	
	Sleep (S3)	4.896	4.507	4.589	4.439	4.640	4.343
	Off (S5)	2.245	2.191	2.266	2.139	2.187	2.115
	Zero Power Mode (EuP)	1.034		1.109		1.034	
Z2 G4 TWR Configuration #3 (TBD)	Processor Info	1x Intel® Xeon® E-2174 3.8 8MB 80W CPU					
	Memory Info	64GB (4x16GB) 2666 MHz DDR4 ECC					
	Graphics Info	1x AMD® Radeon Pro® WX 7100 8GB Graphics					
	Disks/Optical/Floppy	1x6 TB 7.2k rpm Enterprise SATA					
	PSU	500W 90%					
	Other						
Energy Consumption (Watts)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	25.521		26.455		25.836	
	Windows short Idle (S0)	36.013		34.175		37.089	
	Windows Busy Typ (S0)	246.80		239.417		246.027	
	Windows Busy Max (S0)	266.71		263.79		272.09	
	Sleep (S3)	1.840	1.785	1.840	1.837	1.990	1.914 W
	Off (S5)	0.689	0.614	0.749	0.633	0.746	0.622
	Zero Power Mode (EuP)	0.299		0.331		0.300	
Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	87.078		90.264		88.152	
	Windows short Idle (S0)	122.876		116.605		126.548	
	Windows Busy Typ (S0)	842.082		817.075		839.444	
	Windows Busy Max (S0)	910.014		900.051		928.371	
	Sleep (S3)	6.278	6.090	6.278	6.268 r	6.790	6.623
	Off (S5)	2.351	2.095	2.556	2.160	2.545	2.122
	Zero Power Mode (EuP)	1.020		1.129		1.024	
	500W Wide Ranging, Active PFC, 90% Efficient; 250W Wide Ranging, Active PFC, 90% Efficient; The HP Z2 Tower G4 Workstation 500W and 250W PSU Efficiency Report can be found at this link: https://plugloadsolutions.com/psu_reports/HP%20INC_PA-4501-1_500W_SOCE%205175_Report.pdf https://plugloadsolutions.com/psu_reports/ACBEL%20POLYTECH%20INC._PCH022_250W_SOCE%205174_Report.pdf						

System Technical Specifications

Operating Voltage Range	90-269 VAC
Rated Voltage Range	100-240 VAC
Rated Line Frequency	50-60 Hz
Operating Line Frequency Range	47-66 Hz
Rated Input Current	6A @ 100-240V
Heat Dissipation	Typical: 444 btu/hr (112 kcal/hr) Maximum: 1484 btu/hr (374 kcal/hr)
Power Supply Fan	70mm x 70mm x 25mm 4-wire PWM
ENERGY STAR® certified (Config Dependent)	Yes
CECP Compliant @ 220V	Yes
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <1W in S4/S5 - Power Off
Built-in Self Test (BIST) LED	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
Hood Lock Header	Yes
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S4/S5 - Power Off)	Yes
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S4/S5 - Power Off)	Yes

Declared Noise Emissions (Entry-level, Mid-level, and High-end configurations; tested on floor)			
System Configuration (Entry level)	Processor Info	Intel® Core™ i7-8700 3.2 26666 6C CPU	
	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM	
	Graphics Info	Intel® UHD	
	Disks/Optical	1 TB SATA 6Gb/s SSD / No Optical	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.2	13
	Hard drive Operating (random reads)	3.3	13
System Configuration (Mid-level)	Processor Info	Intel® Xeon® processor E-2136	
	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM	
	Graphics Info	NVIDIA® Quadro® P4000 8GB	
	Disks/Optical	2 x 2TB SATA 7200 rpm 6Gb/s 3.5" HDD / No Optical	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.6	18

System Technical Specifications

	Hard drive Operating (random reads)	3.8	22
System Configuration (High-end)	Processor Info	Intel® Core™ i7-8700K 3.7 2666 6C CPU	
	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM	
	Graphics Info	NVIDIA® Quadro® P4000 8GB	
	Disks/Optical	2 x 2TB SATA 7200 rpm 6Gb/s 3.5" HDD / No Optical	
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)
	Idle	3.5	18
	Hard drive Operating (random reads)	3.7	21

Environmental Requirements	Temperature	Operating: 5° to 35° C (40° to 95° F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F) Maximum rate of change: 10°C/hr	
	Humidity	Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb	
	Maximum Altitude	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 12,192 m (40,000 feet) Maximum operating temperature is reduced as altitude increases. See Temperature for details.	
	Shock (non-repetitive)	Operating ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating ½-sine: 160 cm/s, 2-3 ms (~105 g) Non-operating square: 422 cm/s, 20 g	
	Vibration	Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz	

Physical Security and Serviceability

Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, except for Screw-In carrier
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less, except for the processor heatsink
Blue User Touch Points	Yes, on tool-less internal chassis mechanisms
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Screw-In
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes

System Technical Specifications

Over-Temp Warning on Screen	Yes
Restore CD/DVD Set	Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original operating system. DRDVD will provide all drivers for the system. The DRDVD may also contain applications that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP Support.
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed.
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power Supply Diagnostic LED	Yes
Front Power Button	Yes, ACPI multi-function
Front Power LED	Yes, white (normal), red (fault)
Front Hard Drive Activity LED	Yes, white
Front ODD Activity LED	Yes
Internal Speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
Cooling Solutions	Air cooled forced convection
Power Supply Fans	70mm x 70mm x 25mm 4-wire PWM (non-serviceable)
CPU Heatsink Fan	Mainstream (<=65W): 92 mm x 92 mm x 52.5 mm Performance (<=95W): 94mm x 100.2mm x 110mm
Chassis Fan	92mm x 92mm x 25mm 4-wire PWM (non-serviceable)
Memory Heatsink Fan	No

System Technical Specifications

HP PC Hardware Diagnostics UEFI	HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support.
Access Panel Key Lock	No
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI). • Allows the system to wake from a low power mode. • Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
Integrated Chassis Handles	Rear Recessed Handle; optional Optical Bay Front Handle available.
Power Supply	Requires T15 Torx or flat blade screwdriver
PCI Card Retention	Yes, rear (all), middle (optional), front (full-length cards with extender)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes

System Technical Specifications

Social and Environmental Responsibility

Eco-Label Certifications & Declarations This product is low halogen except for power cords, cables and peripherals. Service parts obtained after purchase may not be Low Halogen:

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- IT ECO declaration

Batteries

The battery in this product complies with EU Directive 2006/66/EC
Battery size: CR2032 (coin cell)
Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage

This product meets the material restrictions specified in HP's General Specification for the Environment. <http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf>
HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

End-of-Life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:
Living Progress Report <http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Eco-label certifications
<http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html>

ISO 14001 certificates:
<http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html>

Additional Information

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product is >90% recycle-able when properly disposed of at end of life
- EPEAT Gold registered in the United States. See <http://www.epeat.net> for registration status in your country. EPEAT® registered where applicable. EPEAT registration varies by country. See <http://www.epeat.net> for registration status by country. Search keyword *generator* on HP's 3rd party option store for solar energy accessory at <http://www.hp.com/go/options>

Packaging

HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html

System Technical Specifications

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting

Packaging Materials

Internal

Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expanded-polypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).

External

Carton made from corrugated fiberboard with at least 35% recycled content.

Manageability

Intel® Active Management Technology (AMT) v12

An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 12 includes the following advanced management functions:

- Support for configuration of Intel AMT 12.0 new capabilities
- No reset after provisioning
- Support for Microsoft Windows Server 2012 R2
- Support for New Microsoft SQL Server Versions including Standard and Enterprise editions
- Support for Intel SSD Prop 2500 Series
- Support for Intel Enterprise Digital Fence
- The Platform Discovery Utility can now discover these additional Intel products:
- Intel SSD Pro 2500 Series; Enterprise Digital Fence
- Intel Identity Protection Technology with One Time Password; Public Key Infrastructure; Multi Factor Authentication
- Intel Identity Protection Technology with Intel WiGig
- New Profile Editor and Profile Editor Plugin Interface
- New Required Permissions for Solutions Framework

Intel® vPro™ Technology

The HP Z2 Tower G4 Workstations support Intel® vPro™ technology when purchased with a vPro™ technology capable CPU: Intel® Xeon® E-2100 processor family or 8th Generation Intel® Core™ i5/i7 processors with Intel® VT-d/VT-x and Intel® TXT technology

HP Image Assistant System Software Manager

Visit: <http://ftp.hp.com/pub/caps-softpaq/cmit/HPIA.html>

Visit: <http://www.hp.com/go/ssm>

Service, Support, and Warranty

- Program to proactively communicate Product Change Notifications (PCNs) and CustomerAdvisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.

System Technical Specifications

- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support
-

Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers—no special programs, no additional cost—no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors

Product

Offering

Intel® Xeon® E-2124 3.4 8M GT2 4C

Intel® Xeon® E-2144 3.6 8M GT2 4C

Hard Drives

Product

Offering

512GB M.2 TLC 1st SSD

1TB 7200 RPM SATA 1st HDD

Graphics

Product

Offering

NVIDIA® Quadro® P620 2GB

NVIDIA® Quadro® P1000 2GB

AMD Radeon™ Pro WX 3100 2GB

Technical Specifications - Processors

Intel® Xeon® processor E-2100 family

Intel® Xeon® E-2176G 6C 3.7/4.7 HT 80W CPU
Intel® Xeon® E-2174G 4C 3.8/4.7 HT 71W CPU
Intel® Xeon® E-2144G 4C 3.6/4.5 HT 71W CPU
Intel® Xeon® E-2136 6C 3.3/4.5 HT 80W CPU
Intel® Xeon® E-2126G 6C 3.3/4.5 nHT 80W CPU
Intel® Xeon® E-2124G 4C 3.4/4.5 nHT 71W CPU
Intel® Xeon® E-2104G 4C 3.2/3.2 nHT 65W CPU

8th generation Intel® Core™ processor family

Intel® Core™ i7-8700K 3.7 2666 6C CPU
Intel® Core™ i7+8700K (Core i7 and 16GB Intel® Optane™ memory*,**) 3.7 2666 6C CPU
Intel® Core™ i7-8700 3.2 2666 6C CPU
Intel® Core™ i7+8700 (Core i7 and 16GB Intel® Optane™ memory*,**) 3.2 2666 6C CPU
Intel® Core™ i5-8600 3.1 2666 6C CPU
Intel® Core™ i5+8600 (Core i5 and 16GB Intel® Optane™ memory*,**) 3.1 2666 6C CPU
Intel® Core™ i5-8500 3.0 2666 6C CPU
Intel® Core™ i5+8500 (Core i5 and 16GB Intel® Optane™ memory*,**) 3.0 2666 6C CPU

8th generation Intel® Core™ i3/Pentium processor family

Intel® Core™ i3-8100 3.6 2400 4C CPU
Intel® Pentium® G5400 3.7 2400 2C CPU

*Intel® Optane™ memory (cache) is sold separately. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z2 Tower/SFF/Mini G4, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core™ processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® Optane™ supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe™ Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 16.5 driver.

**16GB Intel® Optane™ memory Available Fall 2018

Technical Specifications - Hard Drives

SATA Hard Drives for HP Workstations

500GB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity	500GB
Height	1 in; 2.54 cm
Width	Media Diameter 3.5 in; 8.9 cm
	Physical Size 4 in; 10.17 cm
Interface	Serial ATA (6.0Gb/s), NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s
Buffer	32MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 2 ms
	Average 11 ms
	Full Stroke 21 ms
Rotational Speed	7,200 rpm
Logical Blocks	976,773,168
Operating Temperature	41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity	1 Terabyte (1000 GB)
Height	1 in; 2.54 cm
Width	Media Diameter 3.5 in; 8.9 cm
	Physical Size 4 in; 10.17 cm
Interface	Serial ATA (6.0Gb/s), NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600 MB/s
Buffer	64MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 2 ms
	Average 11 ms
	Full Stroke 21 ms
Rotational Speed	7,200 rpm
Logical Blocks	1,953,525,168
Operating Temperature	41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD

Capacity	2TB
Height	1 in; 2.54 cm
Width	Media Diameter 3.5 in; 8.9 cm
	Physical Size 4 in; 10.17 cm
Interface	Serial ATA (6.0 Gb/s), NCQ Enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s
Buffer	64MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 1.0 ms
	Average 11 ms
	Full Stroke 18 ms
Rotational Speed	7,200 rpm
Logical Blocks	3,907,029,168
Operating Temperature	41° to 131° F (5° to 55° C)

Technical Specifications - Hard Drives

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

Capacity	1TB
Protocol	SATA
Form Factor	3.5"
Controller	AHCI
Reliability (MTBF)	2.0M hours
Rated Power On Hours	8760/yr
Annualized Failure Rate (based on Rated POH)	<0.62%
Rated for 24/7/365 operation	YES
Physical Size (Height)	1 in; 2.54 cm
Physical Size (Width)	4 in; 10.17 cm
Media Diameter	3.5 in; 8.9 cm
Interface	Serial ATA (6Gb/s), NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s
Buffer	128MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 0.32ms Average 7.45ms Full Stroke 14.2ms
Operating Temperature	41° to 140° F (5° to 60° C)
Performance	Sequential Read up to 226MB/s Sequential Write up to 226MB/s

Enterprise Class Features High Reliability

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

Capacity	4TB
Protocol	SATA
Form Factor	3.5"
Controller	AHCI
Reliability (MTBF)	2.0M hours
Rated Power On Hours	8760/yr
Annualized Failure Rate (based on Rated POH)	<0.62%
Rated for 24/7/365 Operation	YES
Physical Size (Height)	1 in; 2.54 cm
Physical Size (Width)	4 in; 10.17 cm
Media Diameter	3.5 in; 8.9 cm
Interface	Serial ATA (6Gb/s), NCQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s
Buffer	128MB
Seek Time (typical reads, includes controller overhead, including settling)	Single Track 0.7ms Average 8.5ms

Technical Specifications - Hard Drives

6TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	overhead, including settling)	Full Stroke	15.7ms
	Operating Temperature	41° to 131° F (5° to 55° C)	
	Performance	Sequential Read	up to 226MB/s
		Sequential Write	up to 226MB/s
	Enterprise Class Features	High Reliability	
	Capacity	6TB	
	Protocol	SATA	
	Form Factor	3.5"	
	Controller	AHCI	
	Reliability (MTBF)	2.0M hours	
	Rated Power On Hours	8760/yr	
	Annualized Failure Rate (based on Rated POH)	<0.44%	
	Rated for 24/7/365 Operation	YES	
	Physical Size (Height)	1 in; 2.54 cm	
	Physical Size (Width)	4 in; 10.17 cm	
	Media Diameter	3.5 in; 8.9 cm	
	Interface	Serial ATA (6Gb/s), NCQ enabled	
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s	
	Buffer	128MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	0.7ms
Average		8.5ms	
Full Stroke		15.7ms	
	Operating Temperature	41° to 140° F (5° to 60°C)	
	Performance	Sequential Read	up to 226MB/s
		Sequential Write	up to 226MB/s
	Enterprise Class Features	High Reliability	
	Capacity	500GB	
	Height	0.275 in; 0.7 cm	
	Width	Media Diameter	2.5 in; 6.36 cm
		Physical Size	2.75 in; 6.99 cm
	Interface	Up to 600MB/s	
	Synchronous Transfer Rate (Maximum)	128MB	
500GB SATA 7.2K SED SFF HDD	Buffer	64MB	
	Seek Time (typical reads, includes controller overhead, including settling)	Single Track	1ms
		Average	4.2ms
		Full Stroke	25ms (typical)
	Rotational Speed	7,200 rpm	
	Operating Temperature	32° to 140° F (0° to 60° C)	

Technical Specifications - Hard Drives

HP Solid State Drives (SSDs) for Workstations

HP 256GB SATA 6Gb/s SSD

Capacity	256GB
Height	0.28 in; 0.7 cm
Interface	SATA 6Gb/s
Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequential Read)
Operating Temperature	32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s SED Opal 2 SSD

Capacity	256GB
Height	0.28 in; 0.7 cm
Width	Physical Size
Interface	6Gb/s SATA
Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequential Read)
Operating Temperature	32° to 158° F (0° to 70° C)

HP 512 GB SATA 6Gb/s SSD

Capacity	512GB		
Height	0.28 in; 0.7 cm		
Width	Physical Size	2.5 in; 6.36 cm	
Interface	SATA 6Gb/s		
Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequential Read)		
Operating Temperature	32° to 158° F (0° to 70° C)		

HP 1TB SATA 6Gb/s SSD

Capacity	1TB		
Height	0.28 in; 0.7 cm		
Width	Physical Size	2.5 in; 6.36 cm	
Interface	6Gb/s SATA		
Synchronous Transfer Rate (Maximum)	Up to 500MB/s (Sequential Read)		
Operating Temperature	32° to 158° F (0° to 70° C)		

HP 2TB SATA 6Gb/s SSD

Capacity	2TB
Protocol	SATA
Form Factor	2.5"
Controller	AHCI
NAND Type	3D TLC
Endurance	400TBW (TB Written)
Reliability (MTTF)	1.5M hours
Physical Size (Height)	0.28 in; 0.7 cm
Physical Size (Width)	2.5 in; 6.36 cm
Interface	SATA 6Gb/s
Synchronous Transfer Rate (Maximum)	Up to 550MB/s (Sequential Read)
Operating Temperature	32° to 158° F (0° to 70° C)

Technical Specifications - Hard Drives

		Performance	Sequential Read	530 MB/s
			Sequential Write	500 MB/s
			Random Read	92K IOPS
			Random Write	83K IOPS
PCIe SSDs for HP Workstations	HP Z Turbo Drv G2 256GB TLC PCIe SSD (Z2 MB)	Capacity	256GB	
		Protocol	PCIe	
		Form Factor	M.2 in native slot on motherboard	
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	75TBW (TB Written)	
		Reliability (MTBF)	1.5M hours	
		Interface	PCI Express 3.0 x4 electrical x4 physical	
		Operating Temperature	32° to 158° F (0° to 70° C)	
		Performance	Sequential Read	2800 MB/s
			Sequential Write	320 MB/s (1100 MB/s max/Turbo)
			Random Read	250K IOPS
			Random Write	180K IOPS
	HP Z Turbo Drv G2 512GB TLC PCIe SSD (Z2 MB)	Capacity	512GB	
		Protocol	PCIe	
		Form Factor	M.2 in native slot on motherboard	
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	150TBW (TB Written)	
		Reliability (MTBF)	1.5M hours	
		Interface	PCI Express 3.0 x4 electrical x4 physical	
		Operating Temperature	32° to 158° F (0° to 70° C)	
		Performance	Sequential Read	2800 MB/s
			Sequential Write	660 MB/s (1600 MB/s max/Turbo)
			Random Read	260K IOPS
			Random Write	260K IOPS
	HP Z Turbo Drv G2 1TB TLC PCIe SSD (Z2 MB)	Capacity	1TB	
		Protocol	PCIe	
		Form Factor	M.2 in native slot on motherboard	
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	300TBW (TB Written)	
		Reliability (MTBF)	1.5M hours	
		Interface	PCI Express 3.0 x4 electrical x4 physical	
		Operating Temperature	32° to 158° F (0° to 70° C)	
		Performance	Sequential Read	3000 MB/s

Technical Specifications - Hard Drives

		Sequential Write	1150 MB/s (1700 MB/s max/Turbo)
		Random Read	360K IOPS
		Random Write	330K IOPS
Intel® 905p Series AIC PCIe SSD	Intel® 905p Series AIC 280GB PCIe SSD	Capacity	280GB
		Protocol	PCIe
		Form Factor	PCIe Card, Half Height
		Controller	NVMe
		NVM Type	3DXPoint
		Endurance	5.11 PBW (PB Written)
		Reliability (MTBF)	1.6M hours
		Operating Temperature	32° to 185° F (0° to 85° C)
		Performance	
		Sequential Read	2730 MB/s
		Sequential Write	2280 MB/s
		Random Read	587K IOPS
		Random Write	559K IOPS
	Intel® 905p Series AIC 480GB PCIe SSD	Capacity	480TB
		Protocol	PCIe
		Form Factor	PCIe Card, Half Height
		Controller	NVMe
		NVM Type	3DXPoint
		Endurance	8.76 PBW (PB Written)
		Reliability (MTBF)	1.6M hours
		Operating Temperature	32° to 185° F (0° to 85° C)
		Performance	
		Sequential Read	27100 MB/s
		Sequential Write	2280 MB/s
		Random Read	582K IOPS
		Random Write	561K IOPS

Technical Specifications - Graphics

Integrated Intel® UHD Graphics (Z2 G4)	Form Factor	Integrated in select Intel® Xeon® E, Intel® Core™ i7, and Intel® Core™ i5 processors.
		Check specific platform specifications for selections.
	Graphics Controller	Intel® UHD Graphics
	Memory	Unified Memory Architecture (UMA) frame buffer. Graphics memory is shared with system memory. Size selectable between 64 MB to 1024 MB via BIOS setting. Default size is 64 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel® DVM 5.0), to provide an optimal balance between graphics and system memory use.
	Connectors	Check system platform specifications where Intel® UHD Graphics are available.
	Maximum Resolution	Display Port: 4096 x 2160 HDMI: 4096 x 2160 DVI: 1920x1200 VGA: 2048x1536
	Shading Architecture	NOTE: For HDMI, DVI and VGA outputs, separate adapters may be required. Shader Model 5.0 (It's under confirmation with Intel® for the latest version, TBD)
	Supported Graphics APIs	OpenGL 4.4 DirectX 12
	Available Graphics Drivers	Windows 10

NVIDIA® Quadro® P400 2GB Graphics	Form Factor	Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P400 Graphics Card GP107 GPU 256 CUDA cores Max Power: 30 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s
	Connectors	3mDP Outputs*
	Maximum Resolution	DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	3 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5

Technical Specifications - Graphics

Available Graphics Drivers	DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute , OpenCL Microsoft Windows 10 Microsoft Windows 7 Linux®
	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
Notes	*P400, P620 and P1000 only have mini-DisplayPort™ (mDP) video ports. Note 1: AMO kits for P400, P1000 and Adapters • Two mDP-to-DP Adapters are included in the P400 and P1000 AMO kits. • If mDP-to-DP Adapters are needed, Adapters can be ordered separately: - 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables
Form Factor	Low Profile: 2.713 inches in height × 5.7 inches in length
Graphics Controller	NVIDIA® Quadro™ P620
	GP107 GPU Number of Cores: 512 CUDA® cores Max. Power: 40W Cooling Solution: Active fan heatsink
Bus Type	PCI Express x16
Memory	Size: 2GB DDR5 Clock: 2400Mhz Memory Bandwidth: 80GB/s
Connectors	4 x mDP 1.4
Maximum Resolution	DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
Image Quality Features	10-bit internal display processing pipeline
	10-bit scan-out support
Shading Architecture	Shader Model 5.1
Supported Graphics APIs	DX11, OpenGL 4.3
Available Graphics Drivers	Windows 7 Professional (64-bit and 32-bit) Linux®
	HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

Technical Specifications - Graphics

<http://welcome.hp.com/country/us/en/support.html>

Notes

*P400, P620 and P1000 only have mini-DisplayPort™ (mDP) video ports.

Note 1: AMO kits for P400, P620, P1000 and Adapters

- Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits.
- If mDP-to-DP Adapters are needed, Adapters can be ordered separately:
 - 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables
 - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

AMD Radeon™ Pro WX 3100 4GB Graphics

Form Factor	Low Profile, half length (full-height bracket included)
Graphics Controller	Architecture: Polaris 12 Lexa GL Number of Cores: 512 Stream Processors organized into 8 compute units Power: 50W Cooling Solution: Active Fan Heatsink
Bus Type	PCI Express® x8, Generation 3.0
Memory	Size: 4GB GDDR5 Bandwidth: 96 GB/s Interface: 128-bit
Connectors	2x Mini-DisplayPort™ 1.4 1x DisplayPort™ 1.4 Factory Configured: No video cable adapter included After market option kit: No video cable adapter included Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
Maximum Resolution	DisplayPort™ 1.4: - up to 3x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling.
Display Output	2x Mini-DisplayPort™ 1.4 1x DisplayPort™ 1.4
Shading Architecture	Shader Model 6.0
Supported Graphics APIs	OpenCL™ 2.0, DirectX® 12.0, OpenGL 4.5
Available Graphics Drivers	Windows 10 64-bit Linux® HP qualified drivers may be preloaded or available from the HP support Web site:

Technical Specifications - Graphics

<http://welcome.hp.com/country/us/en/support.html>

Notes

Depending on the card model, native DisplayPort™ connectors and/or certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s) may be required. See www.amd.com/firepro for details.

AMD Radeon™ Pro WX 4100 4GB Graphics

Form Factor Graphics Controller

Low Profile (full-height bracket included)
Polaris 11 Baffin GL XT
GPU: 1024 Stream Processors organized into 16 Compute Units
Power: 50 Watts
Cooling Solution: Active Fan Heatsink

Memory

Size: 4GB GDDR5
Bandwidth: 96 GB/s
Interface: 128-bit

Connectors

4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST support.

Factory Configured: Four mDP-to-DP cable adapters included
After market option kit: Four mDP-to-DP cable adapters included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution

DisplayPort™ 1.4:
- up to 4x 5120 x 2880 x 24 bpp @ 60Hz
- supports Multi-Stream Transport (MST)

Image Quality Features

Advanced support for 8-bit and 10-bit per RGB color component. High bandwidth scaler for high quality up and downscaling

Display Output

4 Mini-DisplayPort™ 1.4 Outputs
FreeSync support

GPU Architecture

GCN 4th Generation

Supported Graphics APIs

DirectX® 12
OpenGL® 4.5
OpenCL™ 2.0
Vulkan™ 1.0

Available Graphics Drivers

Windows 10 64-bit
Linux®

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Notes

1. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

Technical Specifications - Graphics

2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
3. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® Quadro® P1000 4GB Graphics	Form Factor	Dimensions: 2.713" H x 5.7" L Single Slot, Low Profile Cooling: Active Weight: 129 grams
	Graphics Controller	NVIDIA® Quadro® P1000 Graphics Card GP107 GPU 640 CUDA cores Max Power: 47 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 4 GB GDDR5, 2500 MHz Memory Interface: 128-bit memory interface
	Connectors	Memory Bandwidth: 80 GB/s memory bandwidth 4mDP Outputs*
	Maximum Resolution	DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	10-bit internal display processing pipeline 10-bit scan-out support
	Display Output	4 mDP Connectors
	Shading Architecture	Full Microsoft DirectX 12 Shader Model 5.1
	Supported Graphics APIs	OpenGL 4.5 DirectX 12 Vulkan 1.0 API support includes: CUDA C, CUDA C++, DirectCompute, OpenCL
	Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7 Linux®
	Notes	HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html *P400, P620 and P1000 only have mini-DisplayPort™ (mDP) video ports. Note 1: AMO kits for P400, P620, P1000 and Adapters • Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits.

Technical Specifications - Graphics

- If mDP-to-DP Adapters are needed, Adapters can be ordered separately:
 - 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables
 - 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® P2000 5GB Graphics	Form Factor	Dimensions: 4.4"Hx7.9"L Single Slot Cooling: Active Weight: 260 grams
	Graphics Controller	NVIDIA® Quadro® P2000 Graphics Card Power: 75 Watts
	Bus Type	PCI Express 3.0 x16
	Memory	Size: 5GB GDDR5 Memory Bandwidth: 140 GB/s Memory Width: 160-bit
	Connectors	4x DisplayPort™ 1.4 Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.
	Maximum Resolution	DisplayPort™: - up to 5120 x 2880 x 24 bpp @ 60Hz - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3 & 1.4 ready. DL-DVI(I) output: - up to 2560 x 1600 x 32 bpp @ 60 Hz Single Link-DVI(I) output: - up to 1920 x 1200 x 32 bpp @ 60Hz HDMI 2.0 (requires DP to HDMI adapter): 5120 x 2880 x 24 bpp @ 60Hz
	Image Quality Features	12-bit internal display pipeline (hardware support for 12-bit scanout on supported panels, applications and connection) Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology, NVIDIA® Mosaic and nView.
	Display Output	Maximum number of displays - 4 direct attached monitors Maximum number of monitors across all available Quadro® P2000 outputs is 4.

Technical Specifications - Graphics

Shading Architecture	Shader Model 5.1
Supported Graphics APIs	OpenGL® 4.5 DirectX® 12 API support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran software
Available Graphics Drivers	Microsoft Windows 10 Microsoft Windows 7 Professional 64bit Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions HP qualified drivers may be preloaded or available from the HP support Web site: http://welcome.hp.com/country/us/en/support.html
Notes	1. Quadro P2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately. 2. Quadro P2000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

AMD Radeon™ Pro WX 7100 8GB Graphics	Form Factor	Full-Height Single Slot (9.5" Length)
	Graphics Controller	Radeon™ Pro WX 7100 graphics GPU: 2304 Stream Processors organized into 36 Compute Units Power: 130 Watts Cooling Solution: Active Fan Heatsink
	Memory	Size: 8GB GDDR5 Bandwidth: 224 GB/s Interface: 256-bit
	Connectors	4x Display Port™ 1.4 – HDR ready connectors with HBR3 and MST support. Factory Configured: No video cable adapter included After market option kit: No video cable adapter included Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are available as Factory Configuration or Option Kit accessories.
	Maximum Resolution	DisplayPort™ 1.4: - up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)
	Image Quality Features	Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component. High bandwidth scaler for high quality up and downscaling
	Display Output	4 DisplayPort™ 1.4 Outputs FreeSync support

Technical Specifications - Graphics

GPU Architecture GCN 4th Generation

Supported Graphics APIs DirectX® 12
OpenGL® 4.5
OpenCL™ 2.0
Vulkan™ 1.0

Available Graphics Drivers Windows 10 64-bit
Linux®

HP qualified drivers may be preloaded or available from the HP support Web site:

<http://welcome.hp.com/country/us/en/support.html>

Notes

4. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.
5. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
6. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
7. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® Quadro® P4000 8GB Graphics

Form Factor

Dimensions: 4.4"H x 9.5"L
Single-slot, full-height
Weight: 475 grams (without extender)

Graphics Controller

NVIDIA® Quadro® P4000 Graphics Card
GPU: GP104 with 1792 CUDA cores
Power: 120 Watts

Bus Type

PCI Express 3.0 x16

Memory

Size: 8GB GDDR5
Memory Bandwidth: 243 GB/s
Memory Width: 256-bit

Connectors

4 x DisplayPort™ 1.4

Technical Specifications - Graphics

3-pin mini-DIN connector via optional bracket
 1 x 6-pin auxiliary power connector
 4-pin header for stereo signal
 SYNC connector for Quadro® Sync II
 2 x SLI connectors

Factory Configured Option: No video cable adapter included
 After Market Option: No video cable adapter included

Additional DisplayPort™-to-VGA, DisplayPort™-to-HDMI, or DisplayPort™-to-DVI adapters are available as accessories

Maximum Resolution

Dual-link internal TMDS (DVI 1.0):
 - up to 2560 x 1600 x 32 bpp @ 60 Hz

Single-link internal TMDS (DVI 1.0):
 - up to 1920 x 1200 x 32 bpp @ 60 Hz

HDMI™ 2.0b (requires DP to HDMI adapter):
 - up to 5120 x 2880 x 24 bpp @ 60Hz

DisplayPort™:
 - up to 4096 x 2160 x 30 bpp @ 60Hz
 - up to 2560 x 1600 x 30 bpp @ 120 Hz
 - supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Using two DP outputs, the P4000 can drive one dual DP input display with 5120 x 2880 x 30 bpp @ 60Hz resolution.

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.
 HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors
 NVIDIA® 3D Vision™ and other 3D stereo technologies
 NVIDIA® Mosaic and nView

Display Output

Maximum number of displays
 - 4 direct attached monitors

Maximum number of monitors across all available Quadro P4000 outputs is 4.

Shading Architecture

Shader Model 5.1

Supported Graphics APIs

OpenGL 4.5
 DirectX 12
 Vulkan 1.0

API support includes:
 CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics Drivers

Microsoft Windows 10
 Microsoft Windows 7
 Linux - Full OpenGL implementation, complete with NVIDIA® and ARB extensions

HP qualified drivers may be preloaded or available from the HP support Web site:
<http://welcome.hp.com/country/us/en/support.html>

Technical Specifications - Graphics

Notes

1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.
2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P5000 8GB Graphics

Form Factor

Dimensions: 4.4"H x 10.5"L
Dual-slot, full-height
Weight: 815 grams

Graphics Controller

NVIDIA® Quadro® P5000 Graphics Card
GPU: GP104
2560 NVIDIA® CUDA® cores

Bus Type

PCI Express 3.0 x16

Memory

Size: 16GB GDDR5
Memory Bandwidth: 288 GB/s
Memory Width: 256-bit
ECC memory (disabled by default)

Connectors

4 x DisplayPort™ 1.4 (HDR support)
DL-DVI (D)
3-pin mini-DIN connector via optional bracket
1 x 8-pin auxiliary power connector
4-pin header for stereo signal
SYNC connector for Quadro® Sync II
2 x SLI connectors

Factory Configured Option: No video cable adapter included
After Market Option: No video cable adapter included

Additional DisplayPort™-to-VGA, DisplayPort™-to-HDMI, or DisplayPort™-to-DVI adapters are available as accessories

Maximum Resolution

5K support @ 60Hz
1x single-cable 5K monitor, or 2x dual-cable 5k monitors

Image Quality Features

Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.
HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors
NVIDIA® 3D Vision™ and other 3D stereo technologies
NVIDIA® Mosaic and nView Desktop Management

Supported Graphics APIs

DirectX®12 , OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API
support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java, Python, and Fortran

Available Graphics Drivers

Windows 10 64-bit
Windows® 7 64-bit
Linux®

Technical Specifications - Graphics

HP qualified drivers may be preloaded or available from the HP support
Web site: <http://welcome.hp.com/country/us/en/support.html>

Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim DVD Writer	Description	9.5mm height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA/ATAPI
	Dimensions (WxHxD)	128 x 9.5 x 127mm
	Supported Media Types	DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW
	Disc Capacity	DVD-ROM 8.5 GB DL or 4.7 GB standard
	Access Times	Full Stroke DVD < 200 ms (seek) Full Stroke CD < 200 ms (seek)
	Maximum Data Transfer Rates	CD ROM Read CD-ROM, CD-R Up to 24X CD-RW Up to 24X
		DVD ROM Read DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X
	Power	Source SATA DC power receptacle
		DC Power Requirements 5 VDC $\pm$ 5%-100 mV ripple p-p
		DC Current 5 VDC -< 800 mA typical, <1600 mA maximum
	Operating Environmental (all conditions non-condensing)	Temperature 41° to 122° F (5° to 50° C) Relative Humidity 10% to 80% Maximum Wet Bulb Temperature 84° F (29° C)
	Operating Systems Supported	Windows 10, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Linux®
		No driver is required for this device. Native support is provided by the operating system.
	Kit Contents	HP SATA DVD Writer drive, installation guide.

HP 9.5mm Slim DVD-ROM Drive	Description	9.5mm height, tray-load
	Mounting Orientation	Either horizontal or vertical
	Interface Type	SATA / ATAPI

Technical Specifications - Optical and Removable Storage

Dimensions (WxHxD)	128 x 9.5 x 127mm	
Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB
Access Times	DVD-ROM Single Layer	< 110 ms (typical)
	CD-ROM Mode 1	< 110 ms (typical)
	Full Stroke DVD	< 230 ms (typical)
	Full Stroke CD	< 220 ms (typical)
Power	Source	SATA DC power receptacle
	DC Power Requirements	5 VDC $\pm$ 5%-100 mV ripple p-p
	DC Current	5 VDC – <800mA typical, < 1600 mA maximum
Operating Environmental (all conditions non-condensing)	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
	Maximum Wet Bulb Temperature	84° F (29° C)
Operating Systems Supported	Windows 10, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Linux®	
Kit Contents	No driver is required for this device. Native support is provided by the operating system. 9.5mm Slim DVD-ROM Drive, slim SATA data/power cable, installation guide	

HP 9.5mm Slim BDXL Blu-Ray Writer

Description	9.5mm height, tray-load	
Mounting Orientation	Either horizontal or vertical	
Interface Type	SATA/ATAPI	
Dimensions (WxHxD)	128 x 9.5 x 127mm	
Supported Media Types	BD-ROM BD-R BD-RE DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW	
Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
	Blu-ray	25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL)
Access Times	Full Stroke DVD	< 230 ms (seek)
	Full Stroke CD	< 220 ms (seek)

Technical Specifications - Optical and Removable Storage

	Blu-ray	< 230 ms (seek) (Full Stroke Blu-ray)
	Startup Time	(Time to drive ready from tray loading)
		BD-ROM (SL/DL) 25S / 28S
		BD-R (SL/DL) 25S / 28S
		BD-RE (SL/DL) 25S / 28S
		DVD-ROM (SL/DL) 18S / 18S
		DVD-R (SL/DL) 25S / 25S
		DVD-RW 25S
		DVD+R (SL/DL) 25S / 25S
		DVD+RW 25S
		DVD-RAM 45S
		CD-ROM 15S
Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X
		CD-RW Up to 24X
	DVD ROM Read	DVD-RAM Up to 8X
		DVD+RW Up to 8X
		DVD-RW Up to 8X
		DVD+R DL Up to 8X
		DVD-R DL Up to 8X
		DVD-ROM Up to 8X
		DVD-ROM DL Up to 8X
		DVD+R Up to 8X
		DVD-R Up to 8X
	Blu-ray	BD-ROM Up to 6X
		BD-ROM DL Up to 6X
Power	Source	SATA DC power receptacle
	DC Power Requirements	5 VDC $\pm$ 5%-100 mV ripple p-p
	DC Current	5 VDC -900 mA typical, 2000mA maximum
	Operating Environmental Temperature (all conditions non-condensing)	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
Operating Systems Supported	Maximum Wet Bulb Temperature	84° F (29° C)
	Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*.	
	Linux®	
	No driver is required for this device. Native support is provided by the operating system.	
Kit Contents	9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA data/power cable, installation guide	
NOTES	As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not	

Technical Specifications - Optical and Removable Storage

constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP SD Media Card Reader	Description
	e USB3.0-SD4.0
	Interface Type • Support USB 2.0 LPM function • Support USB 3.0 U1/U2/U3 Power saving mode • Support USB 3.0 LTM function.
	Dimensions (WxHxD) Dedicated slot in front bezel (orderable option)
	Supported Media Types i. Secure Digital Card (SD) ii. Secure Digital Support up to 2TB iii. Secure Digital HC (SDHC) iv. Secure Digital XC (SDXC) v. Support SD UHS50 mode vi. miniSD *1 vii. miniSDHC*1 viii. MicroSD*1 ix. MicroSDHC*1 x. MicroSDXC*1 Note: “*1” means Adapter Needed
	Operating Systems Supported No driver is required for this device. Native support is provided by the operating system. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com. See http://www.microsoft.com/windows/windows-7/ for details.

Technical Specifications - Controller Cards

HP Thunderbolt™ 3 PCIe 3-port I/O Card	Data Transfer Rate	Supports up to 40 Gb/s 40,000 Mb/s)
	Devices Supported	Thunderbolt™ certified devices
	Bus Type	PCIe card, full or half height PCIe slots
	Ports	One USB 3.1 Type-C connector (Rear)
	Internal Connectors	One 60-pin board-to-board (FlexIO) connector
	System Requirements	Windows 10 RS3 64-bit, Intel® i5 series or higher processor, 4-GB RAM, 20-GB Hard Drive, available PCIe slot.
	Temperature - Operating	50° to 131° F (10° to 55° C)
	Temperature - Storage	-22° to 140° F (-30° to 60° C)
	Relative Humidity - Operating	20% to 80%
	Compliances	FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD, Taiwan BSMI CNS13438, Korea MIC
	Operating Systems Supported	-Windows 10 RS3 64-bit.
	Kit Contents	HP Thunderbolt™ 3 PCIe 3-port I/O Card, full height and half height bulkhead bracket, DisplayPort™ and GPIO (General-Purpose Input/Output) cable, FlexIO adapter board, Installation documentation and warranty card.

Technical Specifications - Networking and Communications

Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro™ with Intel® AMT 12.0)	Connector	RJ-45
	Controller	Intel® I217LM GbE platform LAN connect networking controller
	Memory	3 KB Tx and 3KB Rx FIFO packet buffer memory
	Data Rates Supported	10/100/1000 Mbps
	Compliance	802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u, 802.3z
	Bus Architecture	PCI Express and SMBus
	Data Transfer Mode	PCIe-based interface for active state operation (S0 state) and SMBus for host and management traffic (Sx low power state)
	Power Requirement	Requires 3.3V (integrated regulators for core Vdc)
	Boot ROM Support	Yes
	Network Transfer Mode	Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)
	Network Transfer Rate	10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps
	Management Capabilities	vPro, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI, Advanced cable diagnostic, loopback modes, AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery (MLD)

Intel® X710-DA2 2-Port SFP+ 10GbE NIC	Connector	2 SFP+ Ports
	Cabling	Twin Axial Cabling up to 10m
	Controller	Intel® Ethernet Controller X710-AM2
	Network Transfer Rates Supported	10GbE (with supported 10GBASE-SR transceivers)
	Data Path Width	PCIe Gen3x8 (compatible with x4)
	Power Requirement	4.3W (typical) (with supported 10GBASE-SR transceivers)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	2.703 x 6.578 inches
	Operating System Driver Support	Windows 10 64-bit Linux®
	Kit Contents	- Intel® X710-DA2 2-Port SFP+ 10GbE NIC with standard height bracket attached - Low-profile bracket - Product Literature

HP 10GbE SFP+ SR Transceiver	Operating Temperature	32°F to 113°F (0°C to 45°C)
	Operating Humidity	0% to 85%, noncondensing
	Dimensions (HxWxD)	0.47 x 0.54 x 2.19 inches

Technical Specifications - Networking and Communications

Kit Contents		HP 10GbE SFP+ SR Transceiver
Intel® X550-T2 2-Port 10GbE NIC	Connector	2 RJ-45
	Cabling	10GbE: Cat6a (or better) up to 100m 5GbE and below: Cat5e (or better) up to 100m
	Controller	Intel® Ethernet Controller X550
	Network Transfer Rates Supported	10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE
	Data Path Width	PCIe Gen3x4
	Power Requirement	11.2W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	5.1 x 2.7 in (without brackets)
	Operating System Driver Support	Windows 10 64-bit Linux®
	Kit Contents	- Intel® X550-T2 2-Port 10GbE NIC with standard height bracket attached - Low-profile bracket - Product Literature
Aquantia® AQN-108 1-Port 5GbE NIC	Connector	1 RJ-45
	Cabling	Cat5e (or better) up to 100m
	Controller	Aquantia® AQC108
	Network Transfer Rates Supported	5GbE, 2.5GbE, 1GbE, 100MbE
	Data Path Width	PCIe Gen3x1
	Power Requirement	3.5W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	3.72 x 3.18 inches (without brackets)
	Operating System Driver Support	Windows 7 64-bit; Windows 10 64-bit; Linux®
	Kit Contents	- Aquantia AQN-108 1-Port 5GbE NIC with standard height bracket attached - Low-profile bracket - Product Literature
Intel® I350-T2 2-Port 1GbE NIC	Connector	2 RJ-45
	Cabling	Cat5e (or better) up to 100m
	Controller	Intel® Ethernet I350 Controller
	Network Transfer Rates Supported	1GbE, 100MbE, 10MbE
	Data Path Width	PCIe Gen2.1x4
	Power Requirement	4.4W (typical)
	Operating Temperature	32° to 131° F (0° to 55° C)
	Dimensions (HxW)	2.75 x 5.5 inches (without brackets)

Technical Specifications - Networking and Communications

Operating System Driver Support	Windows 7 64-bit; Windows 10 64-bit; Linux®
Kit Contents	- Intel® I350-T2 2-Port 1GbE NIC with standard height bracket attached - Low-profile bracket - Product Literature

Intel® I350-T4 4-Port 1GbE NIC	Connector Cabling Controller Network Transfer Rates Supported Data Path Width Power Requirement Operating Temperature Dimensions (HxW) Operating System Driver Support Kit Contents	4 RJ-45 Cat5e (or better) up to 100m Intel® Ethernet I350 Controller 1GbE, 100MbE, 10MbE PCIe Gen2.1x4 5W (typical) 32° to 131° F (0° to 55° C) 2.75 x 5.5 inches (without brackets) Windows 7 64-bit; Windows 10 64-bit; Linux® - Intel® I350-T4 4-Port 1GbE NIC with standard height bracket attached - Low-profile bracket - Product Literature
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Intel® 9560 802.11ac, BT 5, M.2	WLAN Standards Antenna Bluetooth Standards Operating Temperature Interface Dimensions Kit Contents	802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w, 802.11r, 802.11k, 802.11v 802.11ac Wave 2 (up to 1.73Mbps, 160MHz Channels, MU-MIMO) 2x2 Dual-Band 5 32° to 131° F (0° to 55° C) M.2 CNVio M.2 2230 Not Available
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HP Power Cord Kit	DM293A
HP Serial Port Adapter	3TK82AA

HP eSATA PCI Cable Kit	Part Number	FH966AA
	Features	1x eSATA ports - Bring the same ultra-fast SATA performance that you demand from your internal SATA hard drives to an external eSATA hard drive. - Faster transfer rates than existing external storage solutions: USB 2.0 & 1394. - Complete motherboard to eSATA PCI bracket solution. - Robust and user friendly external eSATA connector.

Part Number	4KY89AA
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Technical Specifications - Networking and Communications

Z2 G4 TWR Bezel w/ Dust Filter option

Workstations are deployed in a variety of different ways and in different environments, from under a desk to manufacturing floors. HP Workstations designed a dust filter option to further protect the system against the ingress of dust and other particles over the life of the system. Test have shown a reduction of dust ingress of up to 32% for the HP Z2 Tower G4 Workstation platform and is cleanable and serviceable by customers. There is also a BIOS setting that will warn customer when it is time to check and clean their filters.

Cleaning and servicing the dust filter

1. After removing the filter from the system bezel (dust filter can be removed without the use of tools from the front bezel), either blow it with and wash with water or use a delicate duster (feather duster) to brush off the filter then rinse it with water.
2. Allow the filter half a day to dry at room temperature (25C at 30%-50% humidity)
3. Temperature of water can be 0-70C, due to the dust filter meeting the SQTm 70C humidity test. Suggested water temperature for best user experience is 0-50C.
4. Normal tap water (and most other types of water) can be used to rinse the filter. Any type of corrosive liquid is restricted.

Enabling the Check Filter warning in the BIOS:

1. Customers must enable the BIOS setting once they receive their filter.
2. To enable, do the following once you see the boot screen for your system: F10 > Advanced > Built-In Device Options > Dust Filter
3. Select to enable the Dust Filter replacement reminder, which can be set for 15, 30, 60, 90, 120, or 180 days. The Reminder will show during POST after the reminder timer has expired.
- 4.

NOTE: customers who anticipate more dust ingress in their environments should set the reminder for a shorter window. Customers anticipating longer ingress can set the reminder for a longer window.

BIOS Warnings

Large enterprise customers deploying multiple systems can centrally enable/control the BIOS warning using the WMI/BCU tool remotely to set the options below:

Dust Filter

- Disable*
- Enable

Dust Filter Reminder (Days)

15, 30, 60*, 90, 120, and 180

Z2 G4 Dust Filter (Filter Only) Part Number

3TQ24AA

This is intended to be a replacement filter for the HP Z2 Tower G4 Workstation in the event that the original filter would need to be replaced.

HP Z2 Tower G4 Workstation Front Card Guide Kit Part Number Features

4KY82AA

This front card guide kit is required to enable added mechanical stability when configuring select graphics cards on the HP Z2 Tower G4 Workstation.

The kit enables added mechanical stability when configuring:

- 3x NVIDIA® NVS NVS 310 or NVS 315 graphics cards

Technical Specifications - Networking and Communications

- 2x NVIDIA® NVS 510 graphics cards
 - 1x NVS 310 plus 1x NVS 510 graphics cards
 - 2x AMD W2100 graphics cards
 - 1x NVIDIA® Quadro® M4000, M5000 graphics cards
 - 1x AMD FirePro W7000 graphics card
-

Technical Specifications – Miscellaneous Features

MISCELLANEOUS FEATURES

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
 - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically)
 - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
 - 2 red + 4 white BIOS recovery is in progress
 - 3 red + 2 white Memory could not be initialized
 - 3 red + 3 white Graphics adaptor could not be found
 - 3 red + 4 white Power supply failure / not connected
 - 3 red + 5 white Processor not installed
 - 3 red + 6 white Current processor does not support an enabled feature
 - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
 - 4 red + 3 white System internal temperature has exceeded its threshold
 - 5 red + 2 white System controller firmware is not valid
 - 5 red + 3 white System controller detected BIOS is not executing
 - 5 red + 4 white BIOS could not complete initialization / PCA failure
 - 5 red + 5 white System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Blue Pull Tabs, and Quick Release Latches for easy Identification

Summary of Changes

Date of change:	Version History:		Description of change:
July 23, 2018	From v1 to v2	Added	AMD FirePro™ WX3100 2GB Graphics specs
July 30, 2018	From v2 to v3	Changed	Number of supported cards for Nvidia P620 changed to 1
September 13, 2018	From v3 to v4	Changed	Supported components, System Configurations and Technical Specifications – Graphics sections, format changes
January 17, 2019	From v4 to v5	Added	Compliance with FIPS 140-2 TPM 2.0
		Removed	HP DX115 Removable Drive Enclosure

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